



Patent No.: H1844

Express Mail Label No.: EV483417739US

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

*In re* Application of: Darin A. Chan, et al. : Confirmation No.: 2464  
Serial No.: 10/791,094 : Art Unit: 2826  
Filed: 3/1/2004 : Examiner: Kevin V. Quinto  
For: TRENCHES TO REDUCE :  
LATERAL SILICIDE  
GROWTH IN  
INTEGRATED CIRCUIT  
TECHNOLOGY

OK  
To  
EM  
NS  
Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

RESPONSE /AMENDMENT AFTER FINAL REJECTION

UNDER 37 C.F.R. §1.116

Sir:

The following Amendment and Remarks are submitted under 37 C.F.R. §1.116 in response to the Final Office Action mailed August 10, 2005, following the amendment format set forth under 37 CFR §1.121. After this introductory section, there are Amendments to the Claims and then Remarks, each starting on a separate page.

Amendments to the Claims consist of cancellation without prejudice of claims 1, 3-11, and 13-15 which are incorporated in a complete listing of the claims.